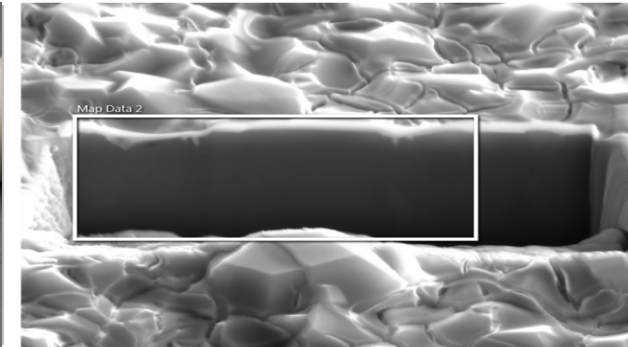
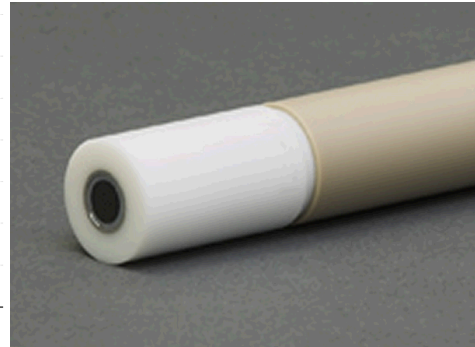
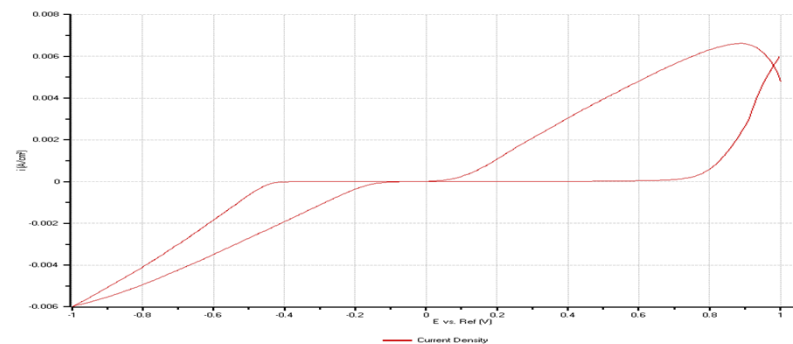


*Exceptional service in the national interest*



# Improving Dispersion Plating of Nickel in Chloroaluminate Ionic Liquids



Jonathan Coleman

Sandia National Laboratories, University of New Mexico

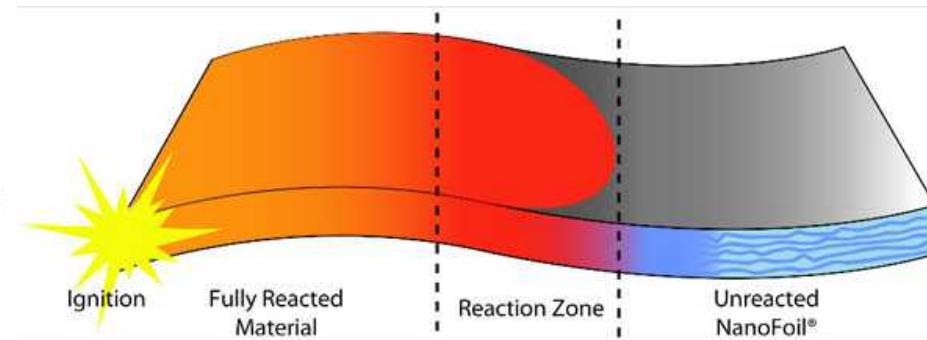
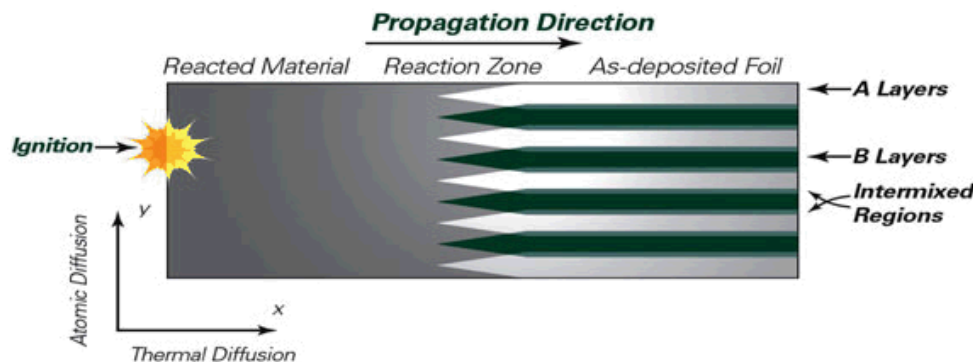
Christopher Applett, Plamen Atanassov

# Exothermic Films

- Codeposition of a composite film
  - Allows for composite foil in a single process step
  - Control over nanostructure
  - Relatively low cost and scalable process
  - Potential for electroforming
- Nickel and aluminum exothermic alloying is suitable performance for thermal batteries
- Properties of exothermic films
  - Reaction rate and heat release are controlled by particle size, shape, distribution and total content

# Nanostructured Thin Films

- Want high energy but no gas generation (using Ni-Al intermetallic)
- Inherently conductive
- Reaction depends on solid state diffusion
  - Can be controlled with nanostructuring and increasing reaction area
    - Improves propagation reliability and speed
    - Higher rates generate higher maximum temperatures
- Achieve this with sputtering
  - Cost prohibitive
    - Material inefficient and can't be made in complex shapes
    - Slow fabrication process that requires high vacuum

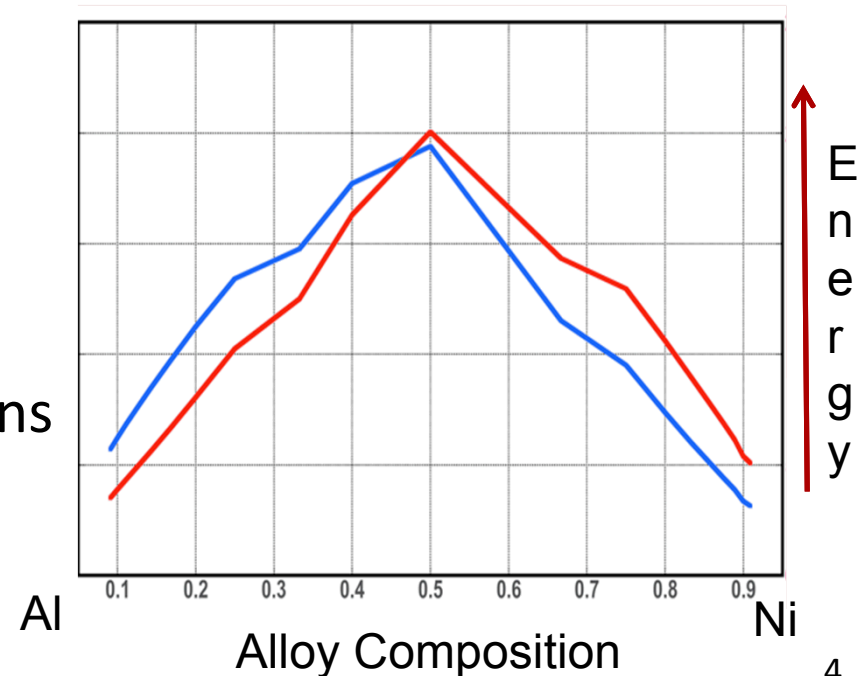


S. Ito, S. Inoue, and T. Namazu "The Size Limit of Al/Ni Multi Layer Rectangular Cuboids for Generating Self-Propagating Exothermic Reaction on a Si Wafer" 2010

T. Namazu, H. Takemoto, H. Fujita, Y. Nagai, and S. Inoue, "Self-Propagating Explosive Reactions in Nanostructured Al/Ni Multilayer Films as A Localized Heat Process Technique for MEMS", 2006

# Reactive Metal Couples (Ni-Al)

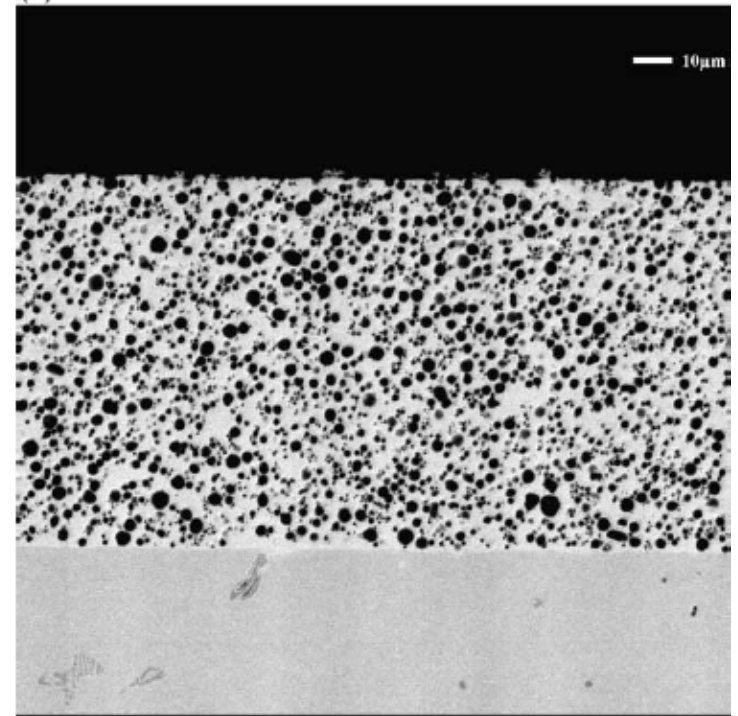
- Reaction rate increases with increasing interfacial area
  - Improves propagation reliability and speed
  - Higher rates generate higher maximum temperatures
  - Metals can diffuse between the interface, decreasing energy of reaction
- Abundant and relatively cheap materials
- High energy output
- Inherently conductive
- Max energy at 50% mole fractions
  - 60% Aluminum by volume



# Objectives

- Aluminum deposition
  - Want high deposition rate
  - Smooth and compact deposition
  - High purity and efficiency
- Nickel incorporation
  - Control over inclusion size
  - Well dispersed
  - Low Ni-Al interfacial alloying

$$x_v = \frac{Kc_v}{1+Kc_v} \frac{zF \cdot \rho_M \cdot v_0}{M \cdot i} \left( \frac{i}{i_0} \right)^\beta \quad V = \frac{2\Delta\rho g a^2}{9\eta}$$



**Composite Film Example:**

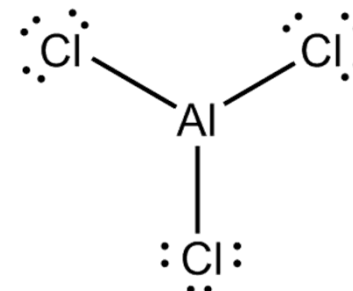
~30% 3 μm particle incorporation

- Investigate particle properties in the electrolyte
  - Agglomeration, surface modifications, migration from settling, diffusion or other means, and effect of different particle geometries
- Important parameters
  - Electrolyte viscosity
  - Particle shape and size
  - Particle-particle interaction
  - Particle-electrolyte interactions

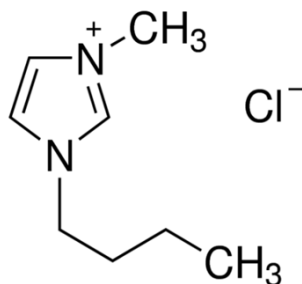
# Deposition of Aluminum Matrix

- Ionic liquids

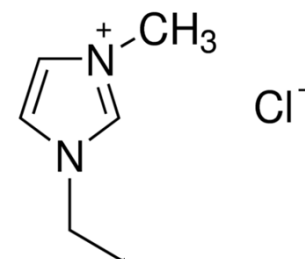
- Chloroaluminate anions deposit aluminum readily
  - High efficiency
  - High purity
- Low vapor pressure and non flammable
- Low diffusion rates
  - Large bulky ions
  - High ionic interactions



- *Particle interactions are not well researched*



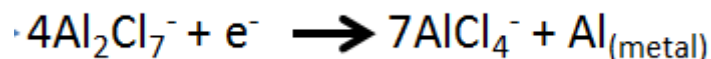
Butyl methylimidazolium Cl (BMIC)



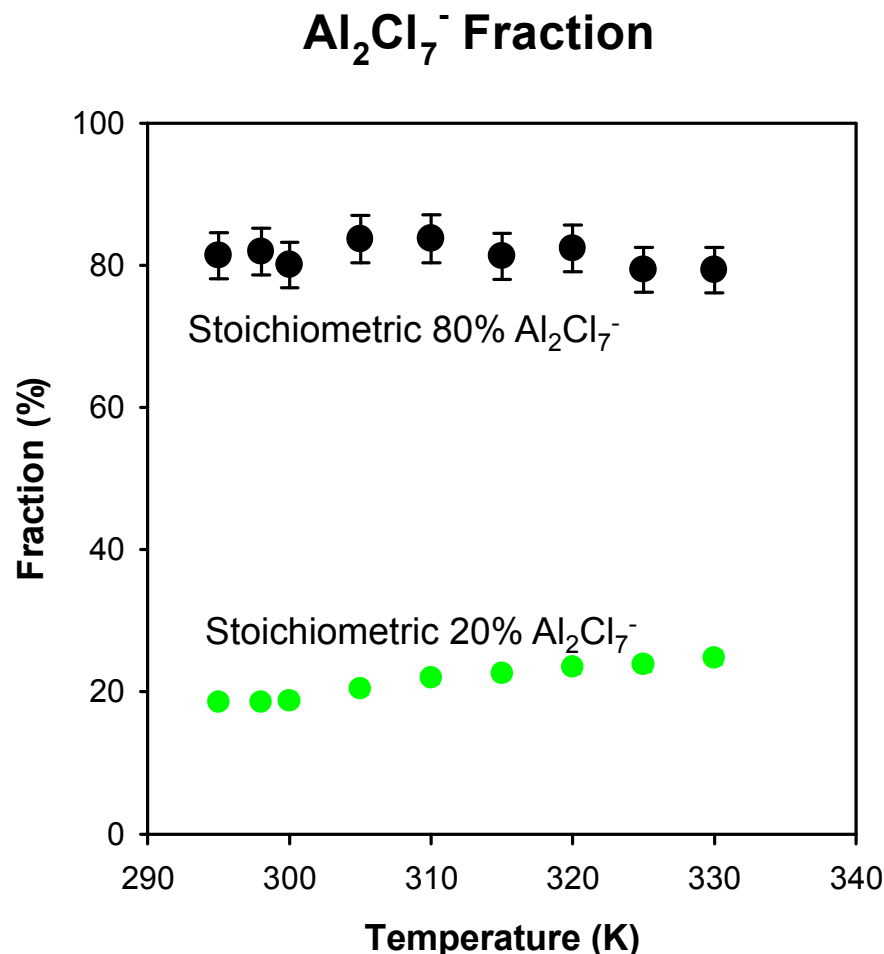
Ethyl methylimidazolium Cl (EMIC)

# Investigation - Speciation

- Aluminum deposition only occurs from specific reduction complexes



- Optimizing these complexes is crucial
  - Concentration
  - Viscosity
  - Particle interaction



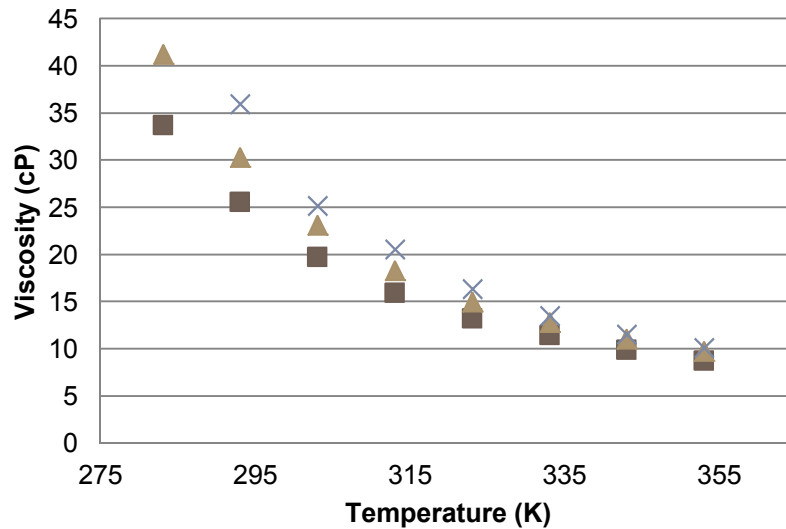
NMR data on speciation at variable temperatures



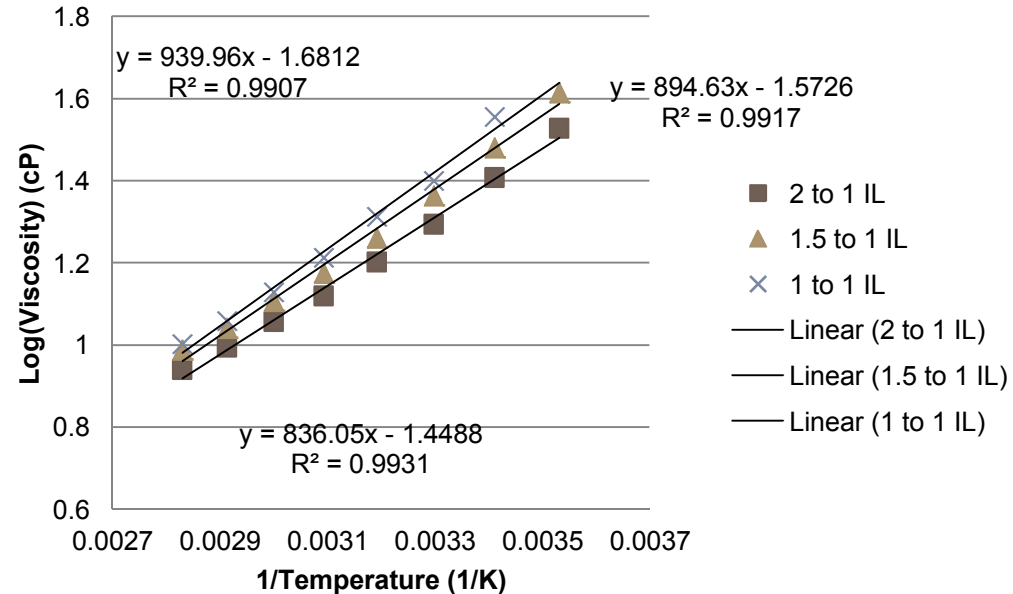
# Viscosity Arrhenius behavior

$$\text{Viscosity} = \mu_0 * e^{\frac{E}{RT}}$$

Viscosity dependence on composition and temperature

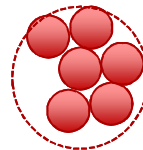
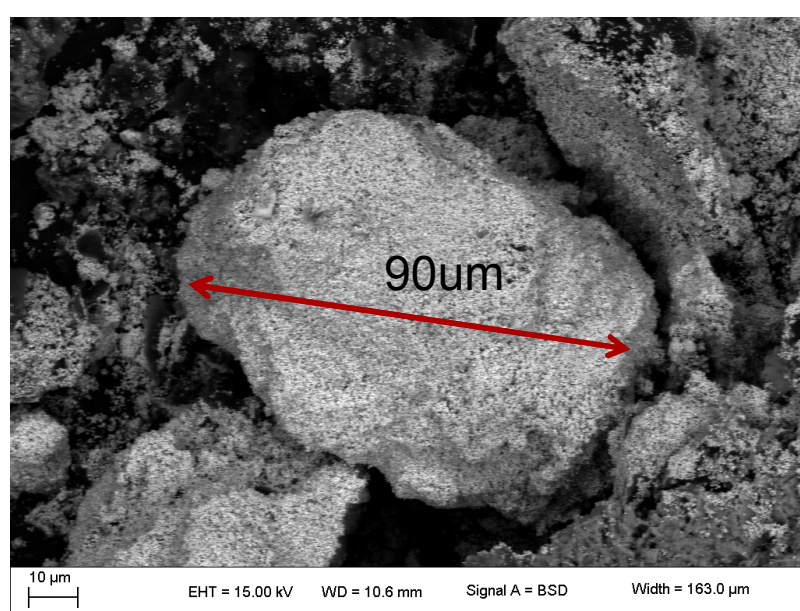


Viscosity dependence on composition and temperature

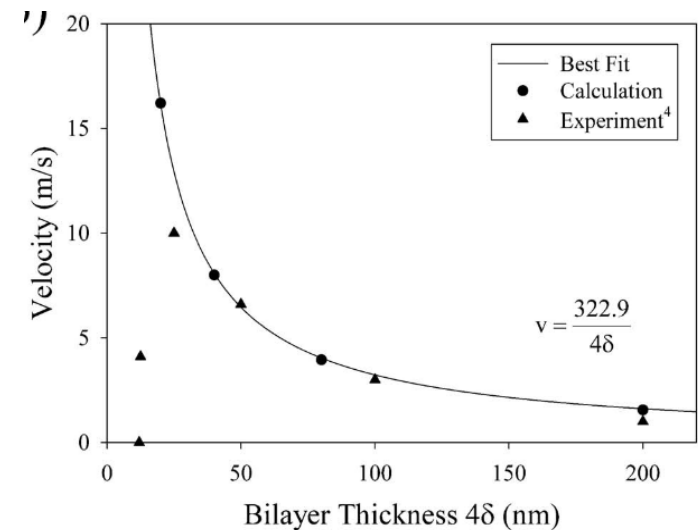


# Particle Size Effects

- Smaller particles increase reaction rate
- Need to keep agglomeration to a minimum with agitation and electrolyte properties/surface functionalization
  - Preventing agglomeration in the electrolyte will minimize agglomerations in the deposited film

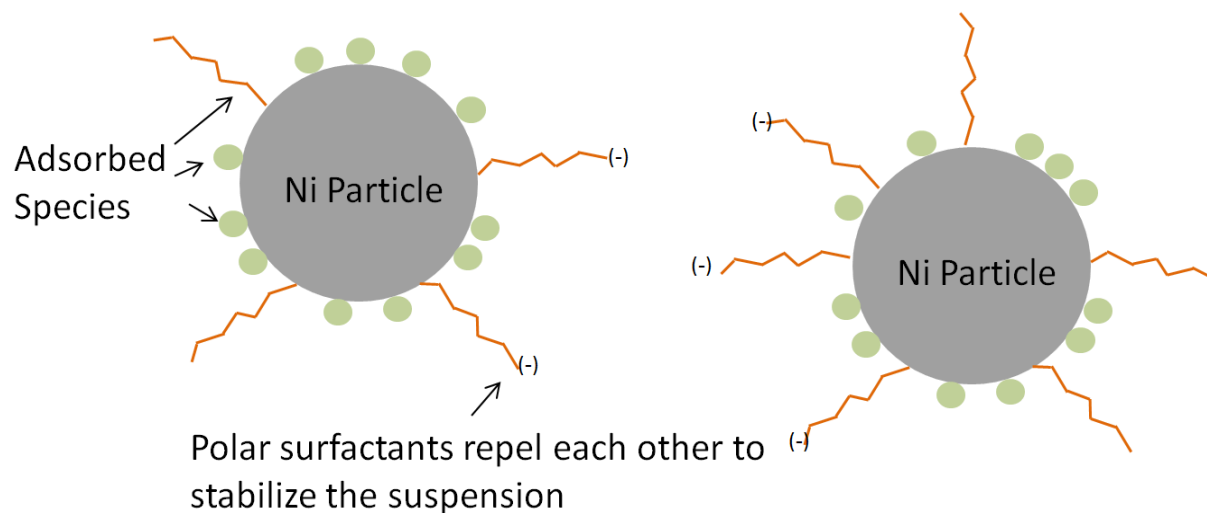


Agglomerations of small particles can mimic large particles



# Particle Properties and Modifications Sandia National Laboratories

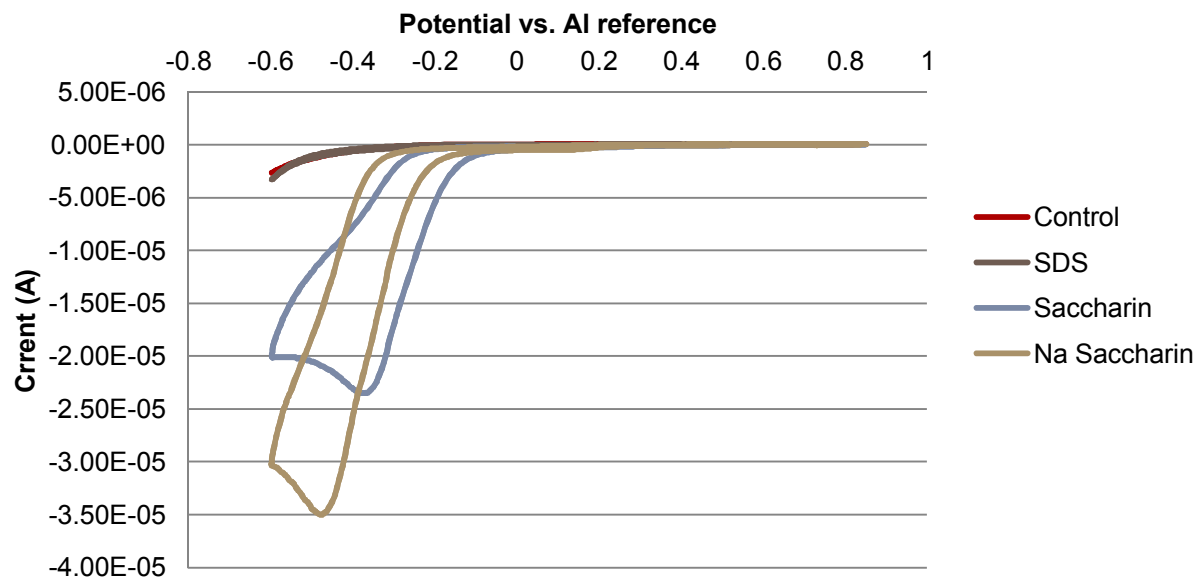
- Particle size, shape and composition
  - Flakes or spheres
  - 10 nm to microns (PVD comparison indicates that ~20 nm particles will be optimal)
  - Ni, NiO, Cu and other options will change the burn properties
- Surface functionalization
  - Surfactants or oxides
  - Modify electrolyte composition



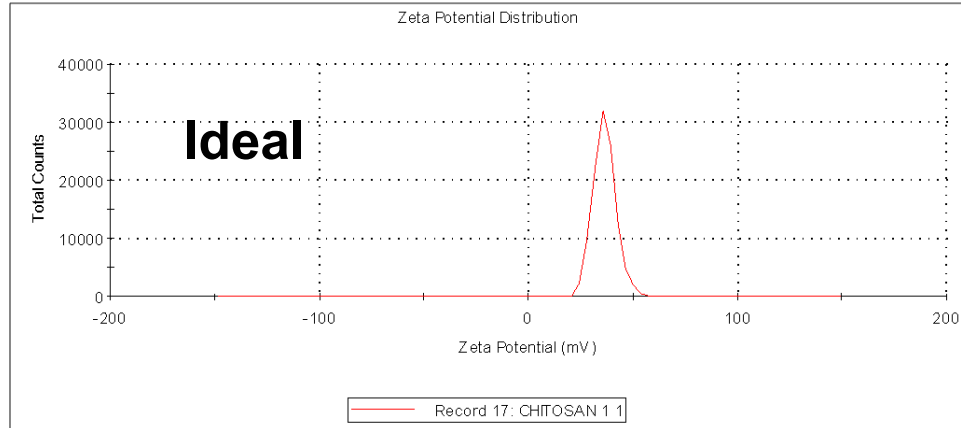
# Electrochemical Stability of Surfactants

- Saccharins reduce in the range of Aluminum deposition and are not compatible
- Sodium dodecyl sulfate (SDS) and Centronium Bromide (CTAB) are compatible
- Particle interaction needs to be investigated

## Electrochemical Stability



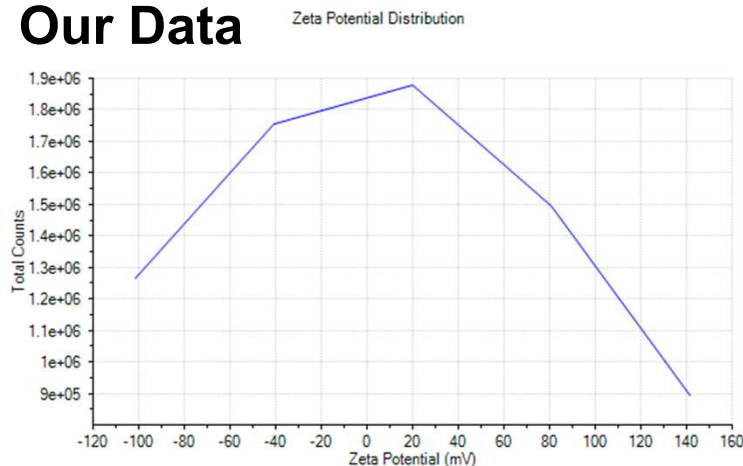
# Zeta Results (Needs more analysis)



Notice resolved at 30,000 counts  
Well understood in aqueous  
Non-conducting particles  
fixed charge on surface

Figure 2: Zeta potential analysis of chitosan nanoparticles, showing mean zeta potential of 40mV as determined by Malvern zeta analyzer

## Our Data



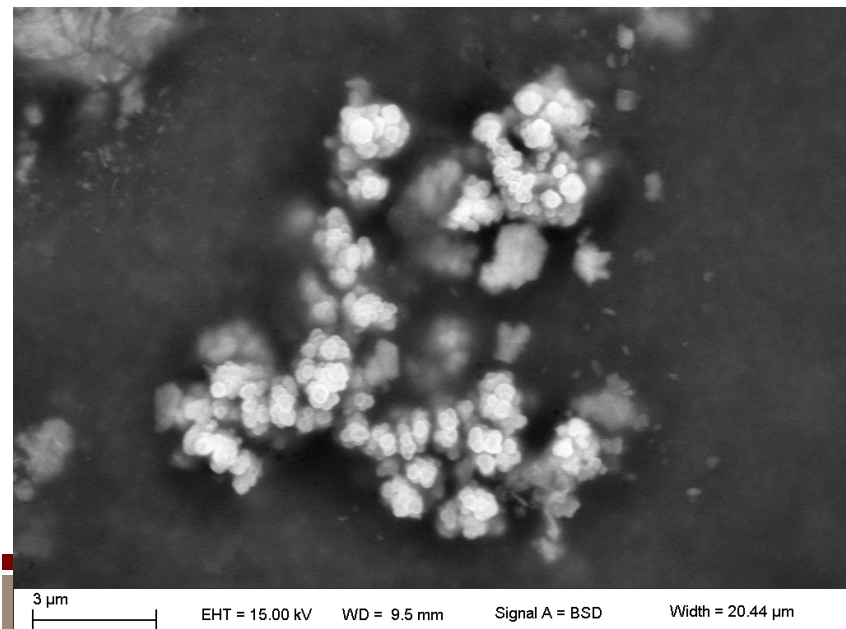
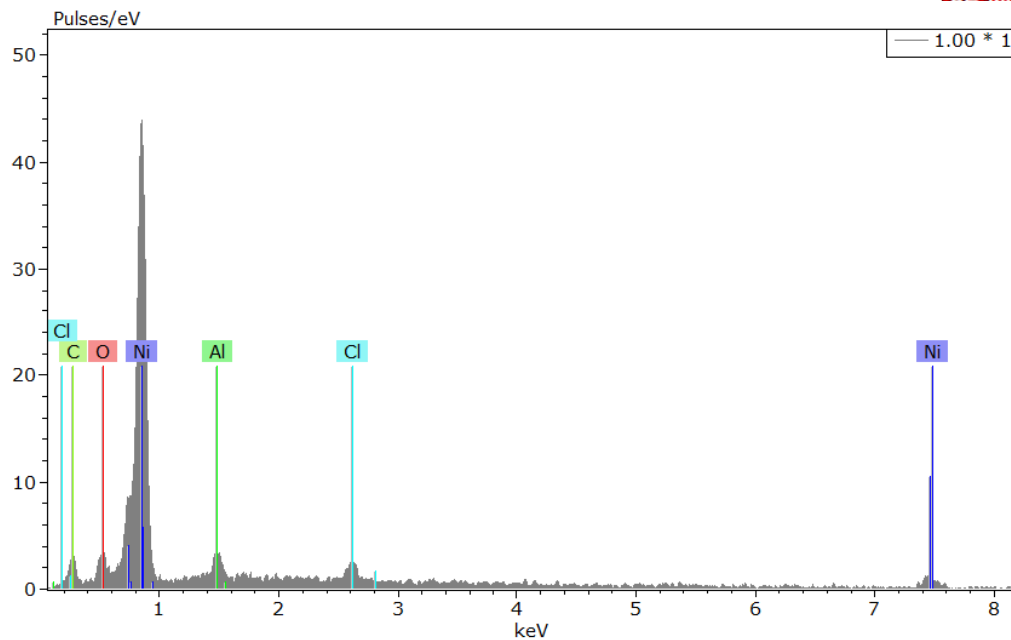
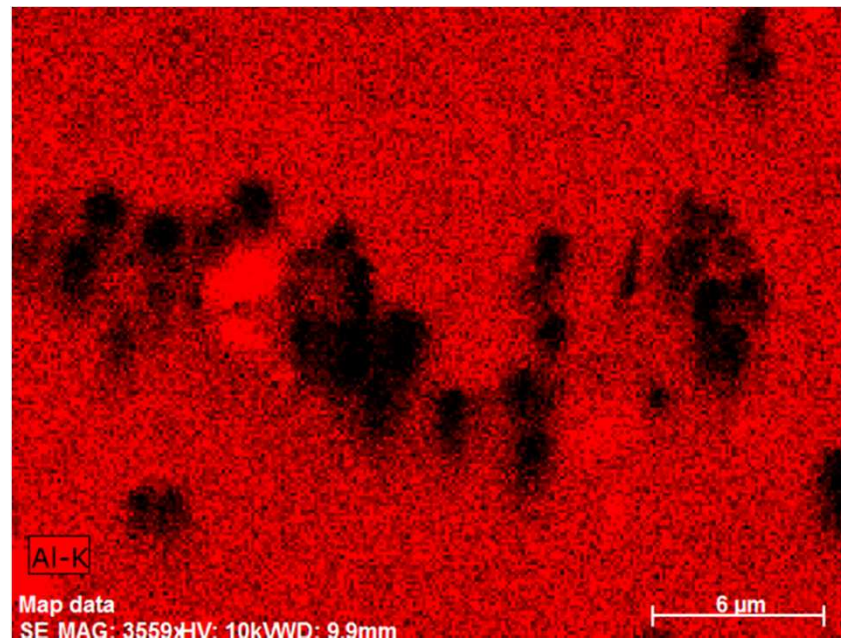
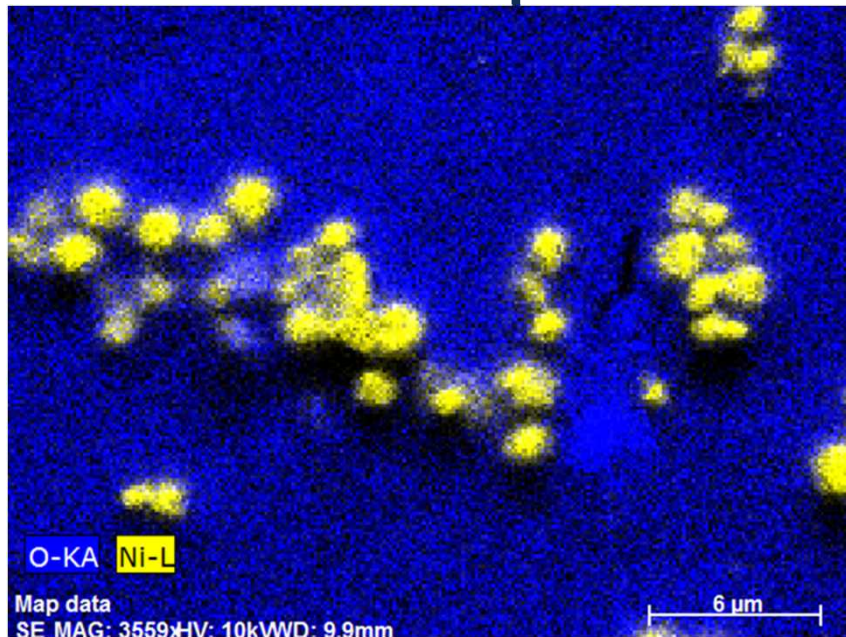
### Summary

Zeta potential: 5.01 mV  
Std. Deviation: 124 mV  
Conductivity: 0.637 mS/cm  
Effective voltage: 3.79 V  
Count Rate: 305.7 kcps  
Peak 1: 11.6 mV / 100.0%

Ni metal (conducting) particles  
Magnetic particles  
Lacking understanding of IL media  
2 million counts and no resolution



# NiO Example Data



# Conclusions

- Viscosity
  - Temperature and composition
- Speciation effects
  - Particle interaction
  - Deposition precursor
- Surfactants in electrolyte
  - Needs investigation
    - Particles are not acquiring specific zeta potentials
  - NiO is not compatible with AlCl precursors
- Tailoring agitation is crucial
  - Physical properties of ILs need to be well documented and deposition vessel well designed

# Acknowledgements

Sandia National Laboratories:

Todd Alam

Alexander Tappan

Robert Knepper

University of New Mexico:

Plamen Atanassov



Funding: Sandia National Laboratories LDRD Program